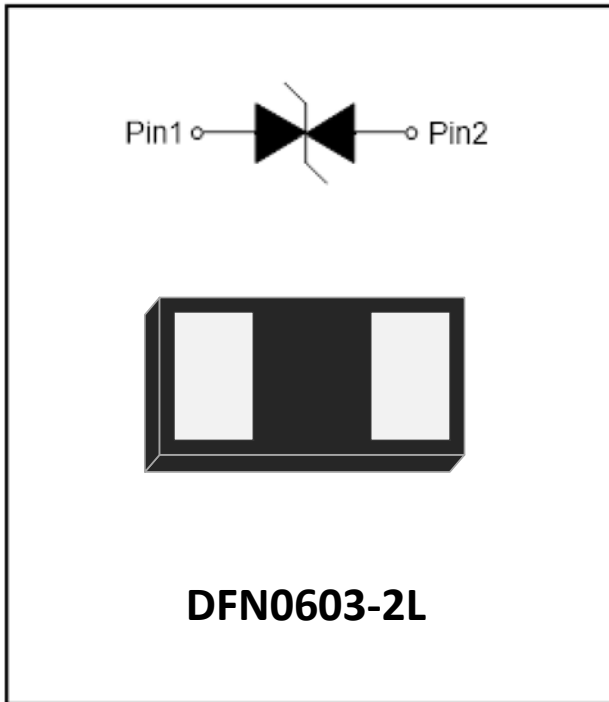


1-Line, Bi-directional, Ultra-low Capacitance Transient Voltage Suppressor



Features

- Stand-off voltage: 5V Max
- Transient protection for each line according to
IEC61000-4-2(ESD): $\pm 20\text{kV}$ (contact)
IEC61000-4-5(surge): 3A (8/20 μs)
- Ultra-low leakage current
- Ultra low clamping voltage
- RoHS Compliant

Applications

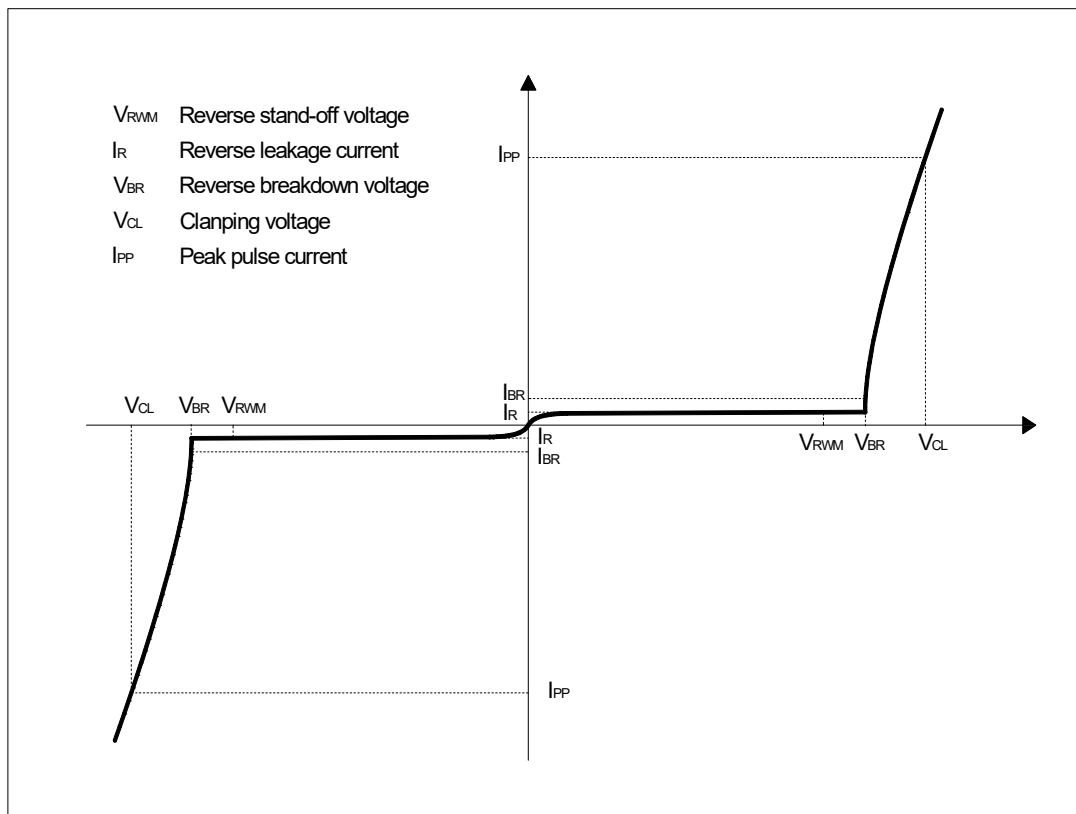
- Cellular Handsets and Accessories
- Display Ports
- MDDI Ports
- USB Ports
- Digital Visual Interface (DVI)
- PCI Express and Serial SATA Ports

Mechanical Data

- Package: DFN0603-2L
- Case Material: "Green" Molding Compound
- Moisture Sensitivity: Level 3 per J-STD-020
- Marking Information: See Below



■Definitions of electrical characteristics





ESDULC5V0LZBS

■Maximum Ratings

PARAMETER	SYMBOL	LIMITS	UNIT
Peak pulse power ($t_p = 8/20\mu s$)	P_{pk}	45	W
Peak pulse current ($t_p = 8/20\mu s$)	I_{pp}	3	A
ESD according to IEC61000-4-2 air discharge	V_{ESD}	± 20	kV
ESD according to IEC61000-4-2 contact discharge		± 20	
Junction temperature	T_J	-55~125	$^{\circ}C$
Storage temperature	T_{STG}	-55~150	$^{\circ}C$

■Electrical Characteristics ($T_a=25^{\circ}C$ Unless otherwise specified)

PARAMETER	Symbol	UNIT	Conditions	Min	Typ	Max
Reverse maximum working voltage	V_{RWM}	V				5
Reverse leakage current	I_R	μA	$V_{RWM} = 5V$			0.2
Reverse breakdown voltage	V_{BR}	V	$I_T = 1mA$	6		
Clamping voltage ¹⁾	V_{CL}	V	$I_{PP} = 1A, t_p = 8/20\mu s$			11
		V	$I_{PP} = 3A, t_p = 8/20\mu s$			15
Junction capacitance	C_J	pF	$V_R = 0V, f = 1MHz$		0.15	0.25
Junction capacitance	C_J	pF	$V_R = 0V, f = 2.5GHz$		0.13	

Notes:

(1). Non-repetitive current pulse, according to IEC61000-4-5.

■Ordering Information (Example)

PREFERED P/N	PACKING CODE	UNIT WEIGHT(mg)	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
ESDULC5V0LZBS	F1	Approximate 0.18	10000	100000	400000	7" reel



■ Characteristics (Typical)

Fig.1 8/20 μ s waveform per IEC61000-4-5

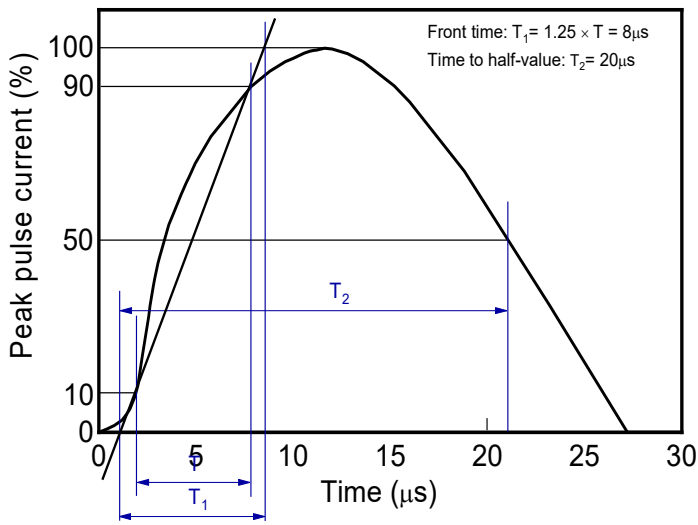


Fig.2 Contact discharge current waveform per IEC61000-4-2

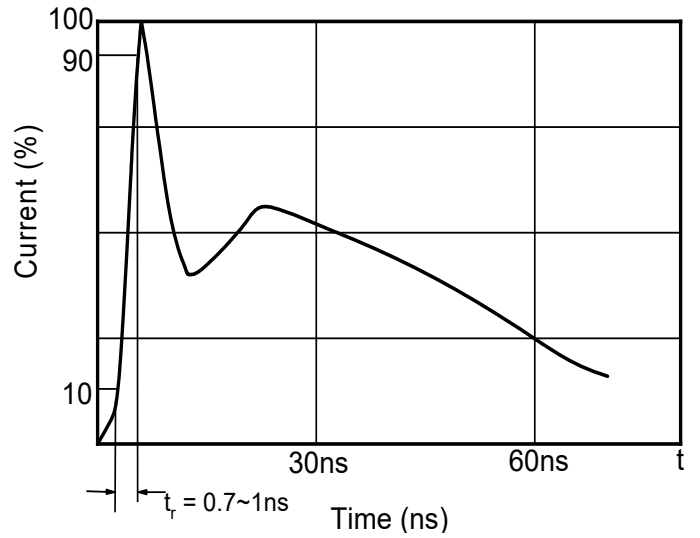


Fig.3 Clamping voltage vs. Peak pulse current

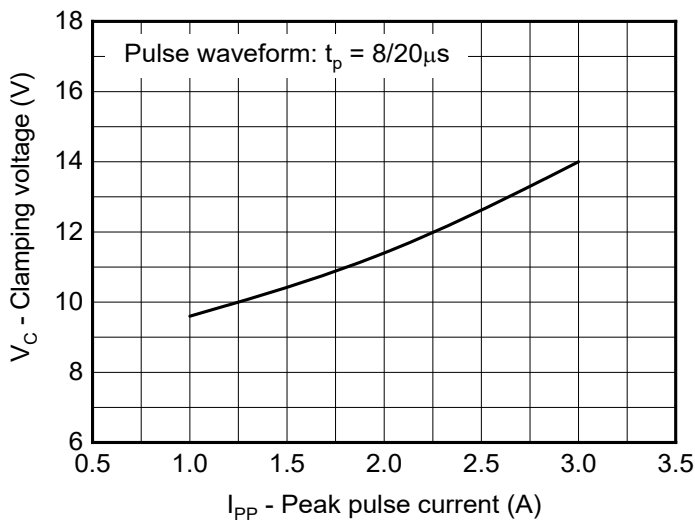


Fig.4 Capacitance vs. Reverse voltage

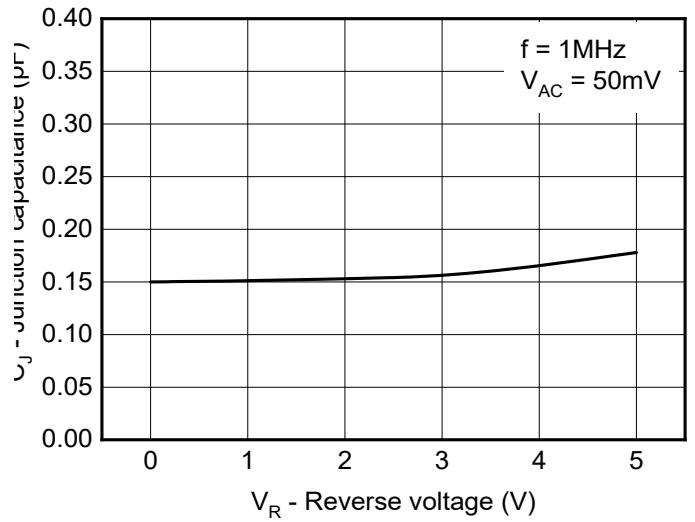


Fig.5 Non-repetitive peak pulse power vs. Pulse time

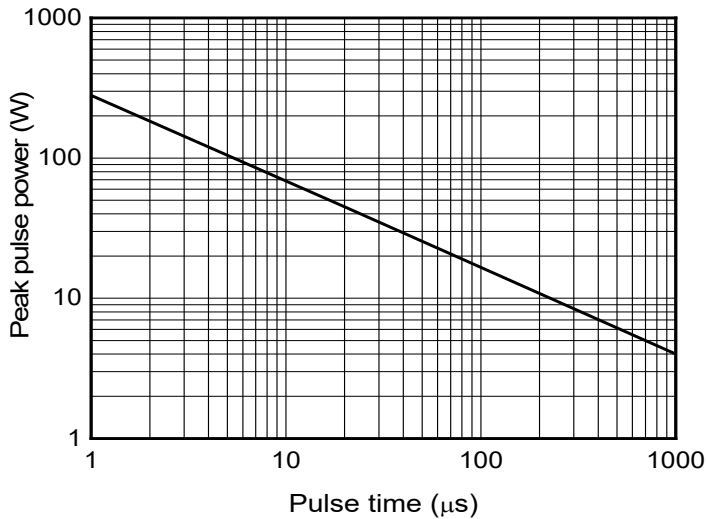
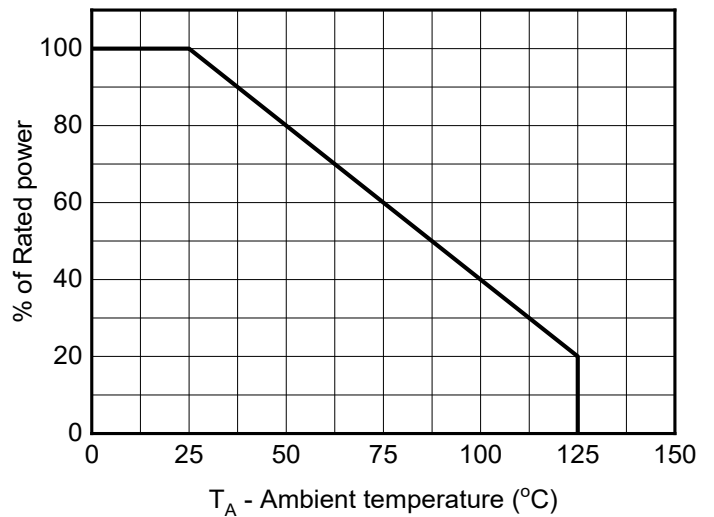


Fig.6 Power derating vs. Ambient temperature





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Fig.7 ESD clamping
(+8kV contact discharge per IEC61000-4-2)

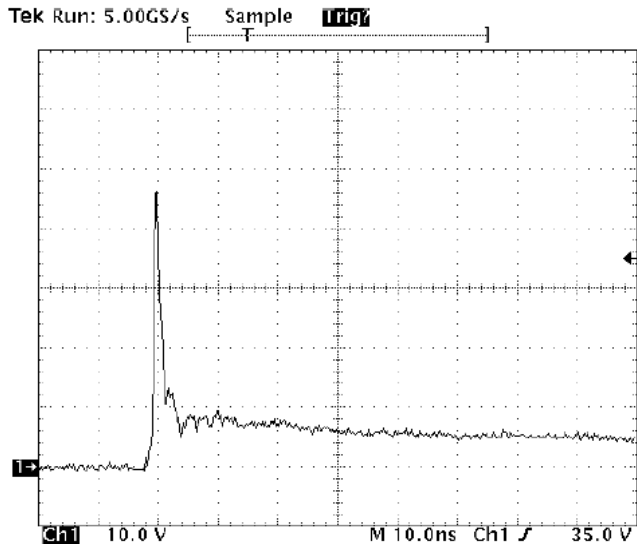
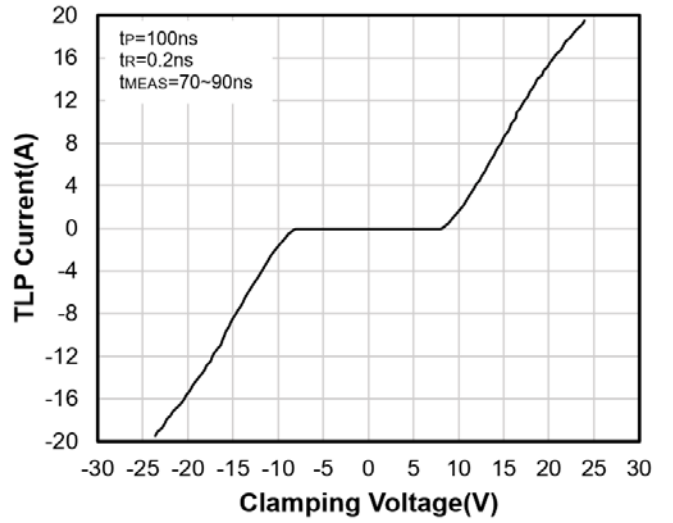
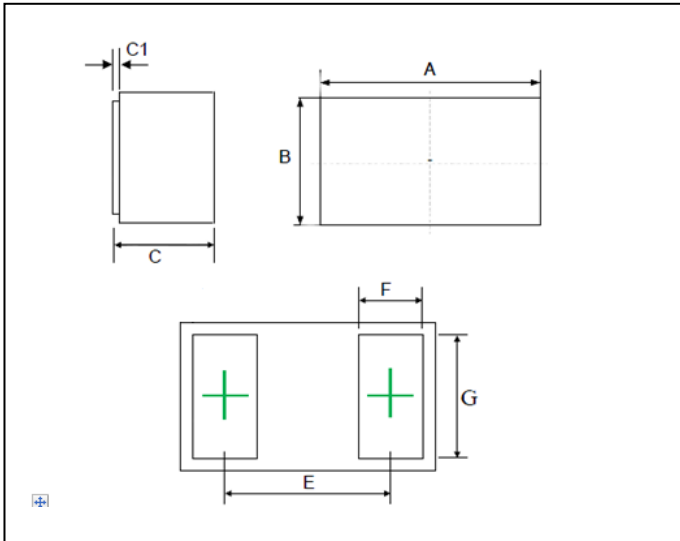


Fig.8 TLP Measurement

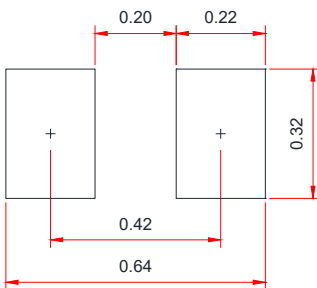


■ Outline Dimensions



Symbol	min. (mm)	Max. (mm)
A	0.55	0.67
B	0.25	0.37
C	0.23	0.34
C1		0.05
E		0.4
F	0.115	0.195
G	0.215	0.295

■ Recommended PCB Layout



Unit:mm

Notes:

This recommended land pattern is for reference purposes only. Please consult your manufacturing group to ensure your PCB design guidelines are met



ESDULC5V0LZBS

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